

GENERAL DESCRIPTION



The ICS8523 is a low skew, high performance 1-to-4 Differential-to-LVHSTL fanout buffer and a member of the HiPerClockS™ family of High Performance Clock Solutions from ICS. The ICS8523 has two selectable clock inputs. The

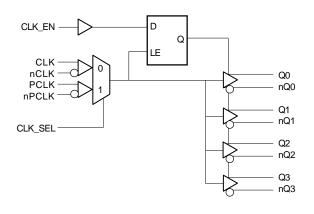
CLK, nCLK pair can accept most standard differential input levels. The PCLK, nPCLK pair can accept LVPECL, CML, or SSTL input levels. The clock enable is internally synchronized to eliminate runt pulses on the outputs during asynchronous assertion/deassertion of the clock enable pin.

Guaranteed output and part-to-part skew characteristics make the ICS8523 ideal for those applications demanding well defined performance and repeatability.

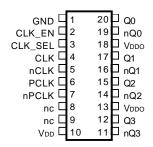
FEATURES

- 4 differential 1.8V LVHSTL outputs
- Selectable CLK, nCLK or LVPECL clock inputs
- CLK, nCLK pair can accept the following differential input levels: LVDS, LVPECL, LVHSTL, SSTL, HCSL
- PCLK, nPCLK supports the following input types: LVPECL, CML, SSTL
- Maximum output frequency up to 650MHz
- Translates any single-ended input signal to 1.8V LVHSTL levels with resistor bias on nCLK input
- Output skew: 30ps (maximum)
- Part-to-part skew: 150ps (maximum)
- Propagation delay: 1.6ns (maximum)
- 3.3V core, 1.8V output operating supply
- 0°C to 70°C ambient operating temperature
- Industrial temperature information available upon request

BLOCK DIAGRAM



PIN ASSIGNMENT



ICS8523
20-Lead TSSOP
6.5mm x 4.4mm x 0.92mm body package
G Package
Top View

Systems, Inc.

TABLE 1. PIN DESCRIPTIONS

Number	Name	Ту	/pe	Description
1	GND	Power		Power supply ground. Connect to ground.
2	CLK_EN	Input	Pullup	Synchronizing clock enable. When HIGH, clock outputs follow clock input. When LOW, Q outputs are forced low, nQ outputs are forced high. LVCMOS / LVTTL interface levels.
3	CLK_SEL	Input	Pulldown	Clock select input. When HIGH, selects differential PCLK, nPCLK inputs. When LOW, selects CLK, nCLK inputs. LVCMOS / LVTTL interface levels.
4	CLK	Input	Pulldown	Non-inverting differential clock input.
5	nCLK	Input	Pullup	Inverting differential clock input.
6	PCLK	Input	Pulldown	Non-inverting differential LVPECL clock input.
7	nPCLK	Input	Pullup	Inverting differential LVPECL clock input.
8, 9	nc	Unused		No connect.
10	V _{DD}	Power		Positive supply pin. Connect to 3.3V.
11, 12	nQ3, Q3	Output		Differential output pair. LVHSTL interface levels.
13, 18	V_{DDO}	Power		Output supply pins. Connect to 1.8V.
14, 15	nQ2, Q2	Output		Differential output pair. LVHSTL interface levels.
16, 17	nQ1, Q1	Output		Differential output pair. LVHSTL interface levels.
19, 20	nQ0, Q0	Output		Differential output pair. LVHSTL interface levels.

NOTE: Pullup and Pulldown refers to internal input resistors. See Table 2, Pin Characteristics, for typical values.

Table 2. Pin Characteristics

Symbol	Parameter	Parameter		Minimum	Typical	Maximum	Units
		CLK, nCLK				4	pF
C _{IN}	Input Capacitance	PCLK, nPCLK				4	pF
		CLK_EN, CLK_SEL				4	pF
R _{PULLUP}	Input Pullup Resisto	or			51		ΚΩ
R _{PULLDOWN}	Input Pulldown Res	istor			51		ΚΩ



TABLE 3A. CONTROL INPUT FUNCTION TABLE

Inputs			Outputs		
CLK_EN	CLK_SEL	Selected Source	Q0 thru Q3	nQ0 thru nQ3	
0	0	CLK, nCLK	Disabled; LOW	Disabled; HIGH	
0	1	PCLK, nPCLK	Disabled; LOW	Disabled; HIGH	
1	0	CLK, nCLK	Enabled	Enabled	
1	1	PCLK, nPCLK	Enabled	Enabled	

After CLK_EN switches, the clock outputs are disabled or enabled following a rising and falling input clock edge as shown in Figure 1.

In the active mode, the state of the outputs are a function of the CLK , nCLK and PCLK, nPCLK inputs as described in Table 3B.

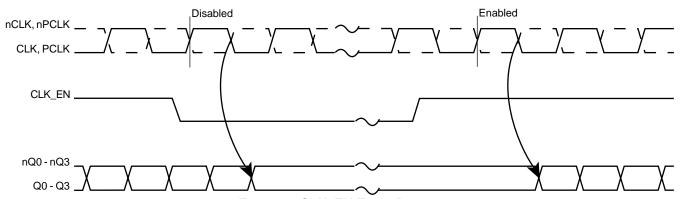


FIGURE 1 - CLK_EN TIMING DIAGRAM

TABLE 3B. CLOCK INPUT FUNCTION TABLE

In	puts	Out	puts	Innut to Output Mode Polovity	
CLK or PCLK	nCLK or nPCLK	Q0 thru Q3	nQ0 thru nQ3	Input to Output Mode	Polarity
0	0	LOW	HIGH	Differential to Differential	Non Inverting
1	1	HIGH	LOW	Differential to Differential	Non Inverting
0	Biased; NOTE 1	LOW	HIGH	Single Ended to Differential	Non Inverting
1	Biased; NOTE 1	HIGH	LOW	Single Ended to Differential	Non Inverting
Biased; NOTE 1	0	HIGH	LOW	Single Ended to Differential	Inverting
Biased; NOTE 1	1	LOW	HIGH	Single Ended to Differential	Inverting

NOTE 1: Please refer to the Application Information section on page 8, Figure 9, which discusses wiring the differential input to accept single ended levels.



DIFFERENTIAL-TO-LVHSTL FANOUT BUFFER

ABSOLUTE MAXIMUM RATINGS

Supply Voltage, V_{DDx} 4.6V

Package Thermal Impedance, θ_{JA} 73.2°C/W Storage Temperature, T_{STG} -65°C to 150°C

Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in the *DC Characteristics* or *AC Characteristics* is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

Table 4A. Power Supply DC Characteristics, $V_{DD} = 3.3V \pm 5\%$, $V_{DDO} = 1.8V \pm 0.2V$, $T_A = 0$ °C to 70°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V _{DD}	Input Power Supply Voltage		3.135	3.3	3.465	٧
V _{DDO}	Output Power Supply Voltage		1.6	1.8	2.0	٧
I _{DD}	Power Supply Current				50	mA

Table 4B. LVCMOS / LVTTL DC Characteristics, $V_{DD} = 3.3V \pm 5\%$, $V_{DDO} = 1.8V \pm 0.2V$, Ta = 0°C to 70°C

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
V _{IH}	Input High Voltage	CLK_EN, CLK_SEL		2		3.765	V
V _{IL}	Input Low Voltage	CLK_EN, CLK_SEL		-0.3		0.8	V
	Input High Current	CLK_EN	$V_{DD} = V_{IN} = 3.465V$			5	μA
' ін	Imput High Current	CLK_SEL	$V_{DD} = V_{IN} = 3.465V$			150	μA
	Input Low Current	CLK_EN	$V_{DD} = 3.465 \text{V}, V_{IN} = 0 \text{V}$	-150			μA
^I IL	Input Low Current	CLK_SEL	$V_{DD} = 3.465 \text{V}, V_{IN} = 0 \text{V}$	-5			μA

Table 4C. Differential DC Characteristics, $V_{DD} = 3.3V \pm 5\%$, $V_{DDO} = 1.8V \pm 0.2V$, $T_A = 0$ °C to 70°C

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
	Input High Current	nCLK	$V_{DD} = V_{IN} = 3.465V$			5	μA
I _{IH}	Imput High Current	CLK	$V_{DD} = V_{IN} = 3.465V$			150	μΑ
	Innut Low Current	nCLK	$V_{DD} = 3.465V, V_{IN} = 0V$	-150			μA
I I _{IL}	Input Low Current	CLK	$V_{DD} = 3.465V, V_{IN} = 0V$	-5			μΑ
V _{PP}	Peak-to-Peak Input	Voltage		0.15		1.3	V
V _{CMR}	Common Mode Inpo NOTE 1, 2	ut Voltage;		0.5		V _{DD} - 0.85	V

NOTE 1: For single ended applications the maximum input voltage for CLK and nCLK is $V_{\tiny DD}$ + 0.3V.

NOTE 2: Common mode voltage is defined as V_{IH}.



Table 4D. LVPECL DC Characteristics, $V_{DD} = 3.3V \pm 5\%$, $V_{DDO} = 1.8V \pm 0.2V$, Ta = 0°C to 70°C

Symbol	Parameter	Parameter		Minimum	Typical	Maximum	Units
	Input High Current	PCLK	$V_{DD} = V_{IN} = 3.465V$			150	μA
I _{IH}	Input High Current	nPCLK	$V_{DD} = V_{IN} = 3.465V$			5	μA
	Input Low Current	PCLK	$V_{DD} = 3.465 \text{V}, V_{IN} = 0 \text{V}$	-5			μA
I _{IL}	Input Low Current	nPCLK	$V_{DD} = 3.465 \text{V}, V_{IN} = 0 \text{V}$	-150			μA
V _{PP}	Peak-to-Peak Input Voltage			0.3		1	V
V _{CMR}	Common Mode Inpu	ut Voltage; NOTE 1, 2		1.5		V _{DD}	V

NOTE 1: Common mode voltage is defined as V_{IH}.

NOTE 2: For single ended applications the maximum input voltage for PCLK and nPCLK is $V_{\rm pp}$ + 0.3V.

Table 4D. LVHSTL DC Characteristics, $V_{DD} = 3.3V \pm 5\%$, $V_{DDO} = 1.8V \pm 0.2V$, Ta = 0°C to 70°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V _{OH}	Output High Voltage; NOTE 1		1		1.4	V
V _{OL}	Output Low Voltage; NOTE 1		0		0.4	V
V _{ox}	Output Crossover Voltage		$40\% \times (V_{OH} - V_{OL}) + V_{OL}$		60% x (V _{OH} - V _{OL}) + V _{OL}	V
V _{SWING}	Peak-to-Peak Output Voltage Swing		0.75		1.25	V

NOTE 1: Outputs terminated with 50Ω to ground.

Table 5. AC Characteristics, $V_{DD} = 3.3V \pm 5\%$, $V_{DDO} = 1.8V \pm 0.2V$, $T_A = 0$ °C to 70°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
f _{MAX}	Maximum Output Frequency				650	MHz
t _{PD}	Propagation Delay; NOTE 1	<i>f</i> ≤ 650MHz	1.3		1.6	ns
tsk(o)	Output Skew; NOTE 2, 4				30	ps
tsk(pp)	Part-to-Part Skew; NOTE 3, 4				150	ps
t _R	Output Rise Time	20% to 80% @ 50MHz	300		700	ps
t _F	Output Fall Time	20% to 80% @ 50MHz	300		700	ps
odc	Output Duty Cycle		45		55	%

All parameters measured at 500MHz unless noted otherwise.

The cycle to cycle jitter on the input will equal the jitter on the output. The part does not add jitter.

NOTE 1: Measured from the differential input crossing point to the differential output crossing point.

NOTE 2: Defined as skew between outputs at the same supply voltage and with equal load conditions.

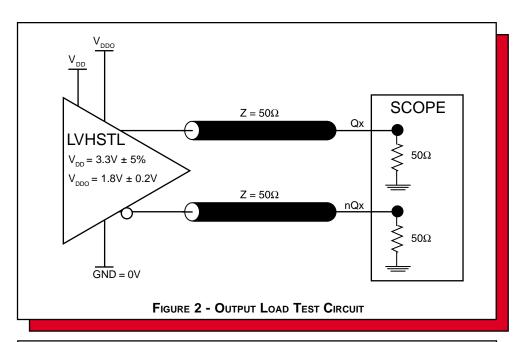
Measured at output differential cross points.

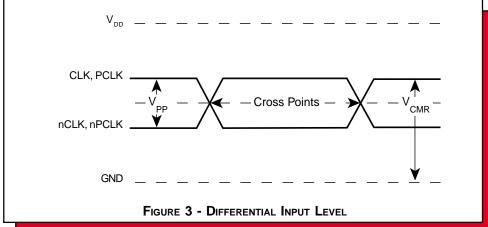
NOTE 3: Defined as skew between outputs on different devices operating at the same supply voltages and with equal load conditions. Using the same type of inputs on each device, the outputs are measured at the differential cross points.

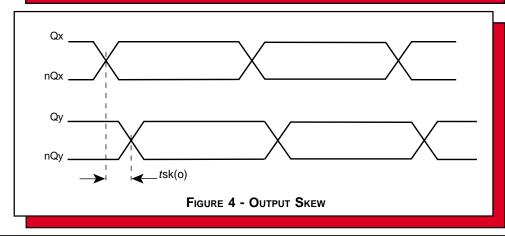
NOTE 4: This parameter is defined in accordance with JEDEC Standard 65.



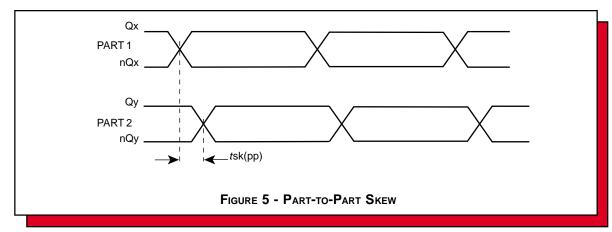
PARAMETER MEASUREMENT INFORMATION

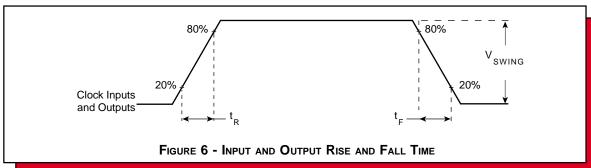


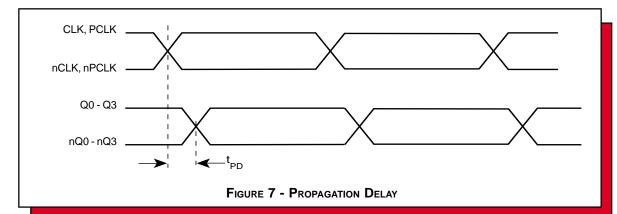


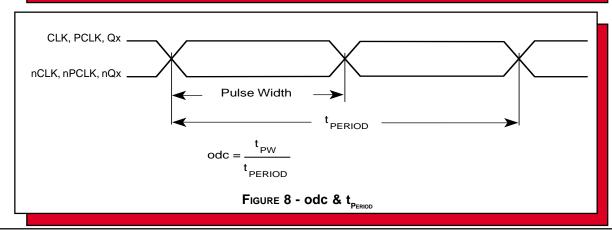








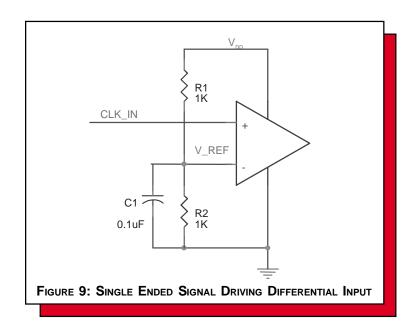






APPLICATION INFORMATION WIRING THE DIFFERENTIAL INPUT TO ACCEPT SINGLE ENDED LEVELS

Figure 9 shows how the differential input can be wired to accept single ended levels. The reference voltage V_REF $_{\text{DD}}$ /2 is generated by the bias resistors R1, R2 and C1. This bias circuit should be located as close as possible to the input pin. The ratio of R1 and R2 might need to be adjusted to position the V_REF in the center of the input voltage swing. For example, if the input clock swing is only 2.5V and V_D = 3.3V, V_REF should be 1.25V and R2/R1 = 0.609.





Power Considerations

This section provides information on power dissipation and junction temperature for the ICS8523. Equations and example calculations are also provided.

1. Power Dissipation.

The total power dissipation for the ICS8523 is the sum of the core power plus the power dissipated in the load(s). The following is the power dissipation for $V_{DD} = 3.3V + 5\% = 3.465V$, which gives worst case results.

NOTE: Please refer to Section 3 for details on calculating power dissipated in the load.

- Power (core)_{MAX} = $V_{DD MAX} * I_{DD MAX} = 3.465 V * 50 mA =$ **173.3 mW**
- Power (outputs)_{MAX} = 32mW/Loaded Output pair If all outputs are loaded, the total power is 4 * 32mW = 128mW

Total Power $_{\text{MAX}}$ (3.465V, with all outputs switching) = 173.3mW + 128mW = 301.3mW

2. Junction Temperature.

Junction temperature, Ti, is the temperature at the junction of the bond wire and bond pad and directly affects the reliability of the device. The maximum recommended junction temperature for HiPerClockS™ devices is 125°C.

The equation for Tj is as follows: $Tj = \theta_{IA} * Pd_{total} + T_{A}$

Tj = Junction Temperature

 $\theta_{1\Delta}$ = junction-to-ambient thermal resistance

Pd_total = Total device power dissipation (example calculation is in section 1 above)

 T_{Δ} = Ambient Temperature

In order to calculate junction temperature, the appropriate junction-to-ambient thermal resistance θ_{10} must be used. Assuming a moderate air flow of 200 linear feet per minute and a multi-layer board, the appropriate value is 66.6°C/W per Table 6 below. Therefore, Tj for an ambient temperature of 70°C with all outputs switching is:

 $70^{\circ}\text{C} + 0.301\text{W} * 66.6^{\circ}\text{C/W} = 90.05^{\circ}\text{C}$. This is well below the limit of 125°C

This calculation is only an example. Tj will obviously vary depending on the number of loaded outputs, supply voltage, air flow, and the type of board (single layer or multi-layer).

Table 6. Thermal Resistance θ_{JA} for 20-pin TSSOP, Forced Convection

	0	200	500
Single-Layer PCB, JEDEC Standard Test Boards	114.5°C/W	98.0°C/W	88.0°C/W
Multi-Layer PCB, JEDEC Standard Test Boards	73.2°C/W	66.6°C/W	63.5°C/W

 θ_{LA} by Velocity (Linear Feet per Minute)

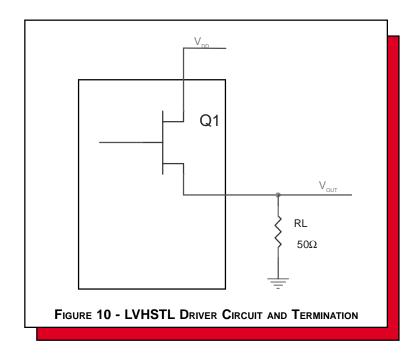
NOTE: Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs.



3. Calculations and Equations.

The purpose of this section is to derive the power dissipated into the load.

LVHSTL output driver circuit and termination are shown in Figure 10.



To calculate worst case power dissipation into the load, use the following equations which assume a 50Ω load, and a termination voltage of V_{DD} - 2V.

Pd_H is power dissipation when the output drives high.

 Pd_L is the power dissipation when the output drives low.

$$\begin{split} & Pd_H = (V_{OH_MAX}/R_L) * (V_{DD_MAX} - V_{OH_MAX}) \\ & Pd_L = (V_{OL_MAX}/R_L) * (V_{DD_MAX} - V_{OL_MAX}) \end{split}$$

• For logic high,
$$V_{OUT} = V_{OH_MAX} = V_{DD_MAX} - 1.2V$$

• For logic low,
$$V_{OUT} = V_{OL_MAX} = V_{DD_MAX} - 0.4V$$

$$Pd_H = (1.2V/50\Omega) * (2V - 1.2V) = 19.2mW$$

 $Pd_L = (0.4V/50\Omega) * (2V - 0.4V) = 12.8mW$

Total Power Dissipation per output pair = Pd_H + Pd_L = 32mW



RELIABILITY INFORMATION

Table 7. $\boldsymbol{\theta}_{_{JA}} \text{vs. A}\text{ir Flow Table}$

θ_{JA} by Velocity (Linear Feet per Minute)

0200500Single-Layer PCB, JEDEC Standard Test Boards114.5°C/W98.0°C/W88.0°C/WMulti-Layer PCB, JEDEC Standard Test Boards73.2°C/W66.6°C/W63.5°C/W

NOTE: Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs.

TRANSISTOR COUNT

The transistor count for ICS8523 is: 472



PACKAGE OUTLINE - G SUFFIX

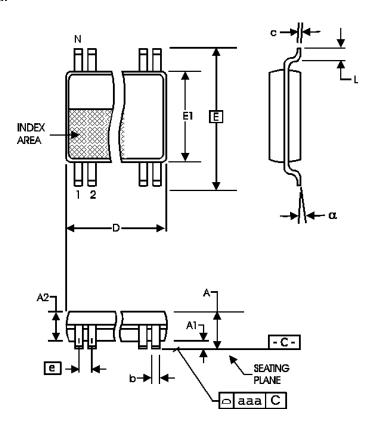


TABLE 8. PACKAGE DIMENSIONS

SYMBOL	Millim	neters
STWBOL	MIN	MAX
N	20	
А		1.20
A1	0.05	0.15
A2	0.80	1.05
b	0.19	0.30
С	0.09	0.20
D	6.40	6.60
E	6.40 E	BASIC
E1	4.30	4.50
е	0.65 E	BASIC
L	0.45	0.75
α	0°	8°
aaa		0.10

Reference Document: JEDEC Publication 95, MS-153

ICS8523

Low Skew, 1-to-4 DIFFERENTIAL-TO-LVHSTL FANOUT BUFFER

TABLE 9. ORDERING INFORMATION

Part/Order Number	Marking	Package	Count	Temperature
ICS8523BG	ICS8523BG	20 lead TSSOP	72 per tube	0°C to 70°C
ICS8523BGT	ICS8523BG	20 lead TSSOP on Tape and Reel	2500	0°C to70°C

While the information presented herein has been checked for both accuracy and reliability, Integrated Circuit Systems, Incorporated (ICS) assumes no responsibility for either its use or for infringement of any patents or other rights of third parties, which would result from its use. No other circuits, patents, or licenses are implied. This product is intended for use in normal commercial applications. Any other applications such as those requiring extended temperature range, high reliability, or other extraordinary environmental requirements are not recommended without additional processing by ICS. ICS reserves the right to change any circuitry or specifications without notice. ICS does not authorize or warrant any ICS product for use in life support devices or critical medical instruments.